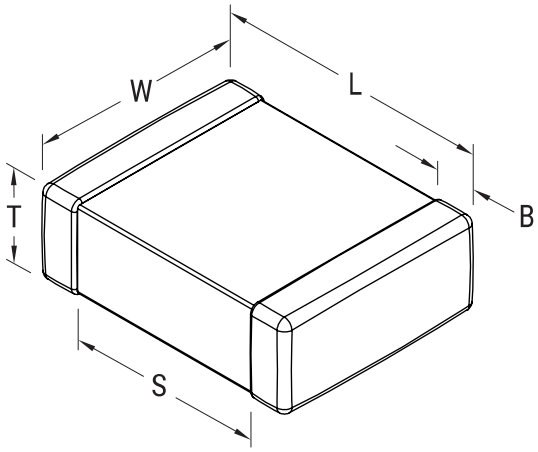
C2225X102JZGACTU

Aliases (C2225X102JZGAC7800)

SMD Comm C0G HV Flex, Ceramic, 1,000 pF, 5%, 2,500 VDC, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, 2225, 3.2 mm



Click here for the 3D model.

General Information	
Series	SMD Comm C0G HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	370 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	2225
L	5.9mm +/-0.75mm
W	6.4mm +/-0.4mm
T	1.6mm +/-0.20mm
S	3.2mm MIN
B	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	1000

Specifications	
Capacitance	1,000 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	2500 VDC
Dielectric Withstanding Voltage	3,000 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	C0G
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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